



- NOTES:
- ALL EXPOSED METALLIZED AREA SHALL BE GOLD PALTED 60 MICRO INCHES MIN. THK. OVER NICKEL PLATING. UNLESS OTHERWISE SPECIFIED IN PURCHASE ORDER.
 - FLATNESS PERTAINS TO METALLIZED PADS ONLY.
 - SEAL RING AND DIE ATTACH PAD ARE NOT GROUND TO A LEAD.(ZERO GROUND)
 - LEAD TO LEAD LEAKAGE MUST NO EXCEED 1 NANO AMPS AT 100 V D.C.

MODIFICATIONS									S=0 D=0
									PA0-18C
									DRAWN CHECKED APPROVED DATE
									M.M T.I T.O K.I Y.S 5.10.'86
									DRAWING NO. SHEET
	CHANGE	DATE	DRAWN	CHECKED	APPROVED	NAME 18 LCC (.164 SQ. CAV.) SCALE 10/1 MATERIAL KYOCERA A-473 KYOCERA CORPORATION KYOTO JAPAN	TOLERANCES: UNLESS OTHERWISE SPECIFIED ± 1% N.L.T ±.005 THRD ANGLE PROJECTION	PB-C86280	

CHANGED DWG NO. AND NAME